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# EDXRF1807 - RoHS Lead-Free Solder-Pak Rapid Screening by XRF



### Scope

The lead-free Solder-Pak is demonstrated for RoHS rapid screening by XRF and WEEE directives.

# Background

The Restriction on Hazardous Substances initiative (RoHS) limits the allowable amount of lead in solder. Energy dispersive X-ray fluorescence (EDXRF) is an accepted analysis technique for the rapid screening by XRF and quantification of the hazardous element according to RoHS norms. To meet the industry needs, Rigaku offers the <u>NEX DE VS</u> analyzer with automatic collimators and a camera for sample positioning and sample image, giving QA/QC technicians the means for fast and simple screening and analysis of materials that must conform to RoHS and similar directives.

RoHS Pb-Free Solder-Pak method: Fundamental Parameters (FP) Matching Library

- FP for flexibility in measuring diverse solder samples
- Method set for typical tin-based or tin-silver solder
- Factory Matching Library for Pb using CRMs
- Flexible Rigaku Matching Library software makes it easy for user to customize the Matching Library or create new Matching Libraries
- · Software includes empirical calibration capability

#### Solder-Pak results - CRM check standard

The Pb-free Solder-Pak comes with one CRM check standard with certified assay for Pb. Measurement results of the CRM check standards are shown here using the Solder-Pak method with Matching Library.

10 mm spot size applicable to NEX DE using autosampler tray for bulk analysis and NEX DE VS using single position point analysis

CRM Check Standard Units: Mass%	
10 mm collimator	Pb
Certified assay	0.107 ± 0.006
NEX DE VS result	0.110

3 mm and 1 mm spot sizes applicable NEX DE VS using single position point analysis.

CRM Check Standard Units: Mass%	
3 mm collimator	Pb
Certified assay	0.107 ± 0.006
NEX DE VS result	0.110

CRM Check Standard Units: Mass%				
1 mm collimator	Pb			
Certified assay	0.107 ± 0.006			
NEX DE VS result	0.104			

Certified assay standard deviation (2-sigma)

### **User-defined RoHS limits**

The Pb-free Solder-Pak comes with the default RoHS Pass/Unsure/Fail judgment settings. NEX DE software allows the user to easily adjust and enter different limits as desired.

	Component	Output	Output digits	Lower limit	Unsure limit	Upper limit
1	Total	Yes	3 effective digits	No limit	No limit	No limit
2	Cr	Yes	3 effective digits	No limit	500.0000	1200.00000
3	Br	Yes	3 effective digits	No limit	500.0000	1200.00000
4	Hg	Yes	3 effective digits	No limit	500.0000	1200.00000
5	Pb	Yes	3 effective digits	No limit	500.0000	1200.00000
6	Cd	Yes	3 effective digits	No limit	50.0000	130.00000
7	As	Yes	3 effective digits	No limit	No limit	No limit
8	Sn	Yes	3 effective digits	No limit	No limit	No limit
9	Sb	Yes	3 effective digits	No limit	No limit	No limit
10	Ba	Yes	3 effective digits	No limit	No limit	No limit
11	Zn	Yes	3 effective digits	No limit	No limit	No limit
12	Polyethylene	Yes	3 effective digits	No limit	No limit	No limit

## **User-definable RoHS report fields**

The flexible Rigaku software allows users to design RoHS report field headers to suit specific reporting needs. Headers to report Sample Name and Analyzed By are automatically set by default, and the user simply enters up to six additional report memo headers as desired.

co Spectrometer Banus		Item	Header	Content	^
	7	Input memo	User name	Setting	
	8	Output folder	Folder	Setting	
	9	File name	File name	Setting	lan i
Administration	10	Completion time	Completion time	Setting	
System Parameters Component Group	11	Input memo	Report No.	Setting	
Sample ID Structure	12	Input memo	Report Date	Setting	
	13	Input memo	Analysis Group	Setting	
	14	Input memo	Lot No.	Setting	
	15	Input memo	Batch ID	Setting	
	16	Input memo 🔹	Part No.	Setting	1
	17				
	18				
	19				~
					*

# Point analysis screen - NEX DE VS

Operator simply selects method, enters sample name and report fields, then presses Start.

	a Processing FP Apple		ation URIY Hantemana Sectionater Salus	- 0 × - 6×
Sample changer . DE-None Atmosph	Position FP analysis Analytical conditi Folder RoHS-F Application PE-Pak VS 10m PE-Pak VS 3mm Solder-Pak 10m Solder-Pak 1mm <	raks ~ Memo ^ m i i m	Memo Sample name Sn Disk 10mm 300sec User name Report No Report Date Analysis Group Lot No Batch 10 Part No Result output Foder Result output	
Camera Setting Position Type Apple P 1 T FP analysis Solder		1 : Sample name Sn Disk 10m		

# **RoHS report**

A RoHS report is automatically generated that includes the user defined fields, sample image, and element judgment.

Report No 22	_			Report Date	June 14, 2018		
t, 14a				Analyzed by:	sbf		
	Hazardous Element Analysis Report Analyzed Date: 6/14/2018 4:22 PM						
1. Sample Informa	tion						
Sample name	s	older Joint					
Lot No.		353428					
Batch ID		66tr44					
Part No.		4756-87			30/		
Material					2/		
2. Analysis Result	s						
Method	Solder-Pak 1mm						
Preparation							
Atomic name	Chromium	Bromine	Lead	Mercury	Cadmium		
Atomic symbol	Cr	Br	РЬ	Hg	Cd		
Judgment	Pass	Pass	Pass	Pass	Pass		
Analyzed value	<0.0001	3.95	0.0029	<0.0001	<0.0001		

# Conclusion

The NEX DE VS with automatic collimators and camera provides excellent sensitivity and reliable precision for RoHS rapid screening by XRF down to 1 mm spot size. Simple Point Analysis Screen allows operators to easily enter report information as designed using customizable report headers and automatically generates an RoHS report complete with sample image, analysis results, and Pass/Unsure/Fail judgment.

# **Related products**



#### **NEX DE Series**

High-power 60 kV EDXRF systems delivering speed, precisi on, and small spot measurements